MIC7111

1.8V IttyBitty™ Rail-to-Rail Input/Output Op Amp

Preliminary Information

General Description

The MIC7111 is a micropower operational amplifier featuring rail-to-rail input and output performance in Micrel's IttyBitty™ SOT-23-5 package. The MIC7111 is ideal for systems where small size is a critical consideration.

The MIC7111 is designed to operate from 1.8V to 11V power supplies.

The MIC7111 benefits small battery operated portable electronic devices where small size and the ability to place the amplifier close to the signal source are primary design concerns.

For other package options, please contact the factory.

Features

- Small footprint SOT-23-5 package
- Guaranteed performance at 1.8V, 2.7V, 5V, and 10V
- 15µA typical supply current at 1.8V
- 25kHz gain-bandwidth at 5V
- Output swing to within 1mV of rails with 1.8V supply and 100kΩ load
- Suitable for driving capacitive loads

Applications

- Wireless and cellular communications
- GaAs RF amplifier bias amplifier
- Current sensing for battery chargers
- Reference voltage buffer
- Transducer linearization and interface
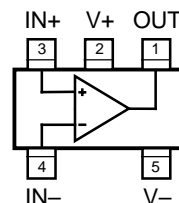- Portable computing

Ordering Information

Part Number	Junction Temp. Range	Package
MIC7111BM5	−40°C to +85°C	SOT-23-5

Pin Configuration

Part Identification
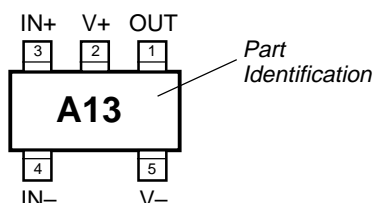
Functional Configuration

SOT-23-5 (M5)

Pin Description

Pin Number	Pin Name	Pin Function
1	OUT	Amplifier Output
2	V+	Positive Supply
3	IN+	Noninverting Input
4	IN–	Inverting Input
5	V–	Negative Suppy

IttyBitty is a trademark of Micrel, Inc.

Absolute Maximum Ratings (Note 1)

Supply Voltage ($V_{V+} - V_{V-}$) 12V

Differential Input Voltage ($V_{IN+} - V_{IN-}$) .... $\pm(V_{V+} - V_{V-})$

I/O Pin Voltage (V_{IN}, V_{OUT}), **Note 2**

.... $V_{V+} + 0.3V$ to $V_{V-} - 0.3V$

Junction Temperature (T_J) .... $+150°C$

Storage Temperature .... $-65°C$ to $+150°C$

Lead Temperature (soldering, 10 sec.) .... $260°C$

ESD, **Note 5** 2kV

Operating Ratings (Note 1)

Supply Voltage ($V_{V+} - V_{V-}$) .... 1.8V to 11V

Junction Temperature (T_J) .... $-40°C$ to $+85°C$

Max. Junction Temperature ($T_{J(max)}$), **Note 3** .... $+85°C$

Package Thermal Resistance (θ_{JA}), **Note 4** .... $325°C/W$

Max. Power Dissipation .... **Note 3**

DC Electrical Characteristics (1.8V)

V_{V+} = +1.8V, V_{V-} = 0V, V_{CM} = V_{OUT} = V_{V+}/2; R_L = 1M; T_J = 25°C, **bold** values indicate $-40°C \leq T_J \leq +85°C$; unless noted

Symbol	Parameter	Condition	Min	Typ	Max	Units
V_{OS}	Input Offset Voltage			0.9	7	mV
					9	mV
TCV_{OS}	Input Offset Voltage Temperature Drift			2.0		µV/°C
I_B	Input Bias Current			1	10	pA
					500	pA
I_{OS}	Input Offset Current			0.01	0.5	pA
					75	pA
R_{IN}	Input Resistance			>10		TΩ
+PSRR	Positive Power Supply Rejection Ratio	$1.8V \leq V_{V+} \leq 5V$, V_{V-} = 0V, V_{CM} = V_{OUT} = 0.9V	60	85		dB
–PSRR	Negative Power Supply Rejection Ratio	$-1.8V \leq V_{V-} \leq -5V$, V_{V+} = 0V, V_{CM} = V_{OUT} = –0.9V	60	85		dB
CMRR	Common-Mode Rejection Ratio	V_{CM} = –0.2V to +2.0V	50	70		dB
C_{IN}	Common Mode Input Capacitance			3		pF
V_{OUT}	Output Voltage Swing	output high, R_L = 100k, specified as $V_{V+} - V_{OUT}$		0.14	1	mV
					1	mV
		output low, R_L = 100k		0.14	1	mV
					1	mV
		output high, R_L = 2k, specified as $V_{V+} - V_{OUT}$		6.8	23	mV
					34	mV
		output low, R_L = 2k		6.8	23	mV
					34	mV
I_{SC}	Output Short Circuit Current **Note 6**	sourcing, V_{OUT} = 0V	15	25		mA
		sinking, V_{OUT} = 1.8V	15	25		mA
A_{VOL}	Voltage Gain	sourcing		400		V/mV
		sinking		400		V/mV
I_s	Supply Current	V_{V+} = 1.8V, V_{OUT} = V_{V+}/2		15	35	µA

AC Electrical Characteristics (1.8V)

V+ = +1.8V, V– = 0V, V_{CM} = V_{OUT} = V_{V+}/2; R_L = 1M; T_J = 25°C, **bold** values indicate $-40°C \leq T_J \leq +85°C$; unless noted

SR	Slew Rate	voltage follower, 1V step, R_L = 100k@0.9V V_{OUT} = $1V_{P-P}$		0.015		V/µs
GBW	Gain Bandwidth Product			25		kHz

DC Electrical Characteristics (2.7V)

V_{V+} = +2.7V, V_{V-} = 0V, V_{CM} = V_{OUT} = V_{V+}/2; R_L = 1M; T_J = 25°C, **bold** values indicate −40°C ≤ T_J ≤ +85°C; unless noted

Symbol	Parameter	Condition	Min	Typ	Max	Units
V_{OS}	Input Offset Voltage			0.9	7 **9**	mV mV
TCV_{OS}	Input Offset Voltage Temperature Drift			2.0		μV/°C
I_B	Input Bias Current			1	10 **500**	pA pA
I_{OS}	Input Offset Current			0.01	0.5 **75**	pA pA
R_{IN}	Input Resistance			>10		TΩ
+PSRR	Positive Power Supply Rejection Ratio	2.7V ≤ V_{V+} ≤ 5V, V_{V-} = 0V, V_{CM} = V_{OUT} = 1.35V	60	90		dB
−PSRR	Negative Power Supply Rejection Ratio	−2.7V ≤ V_{V-} ≤ −5V, V_{V+} = 0V, V_{CM} = V_{OUT} = −1.35V	60	90		dB
CMRR	Common-Mode Rejection Ratio	V_{CM} = −0.2V to +2.9V	52	75		dB
C_{IN}	Common Mode Input Capacitance			3		pF
V_{OUT}	Output Voltage Swing	output high, R_L = 100k, specified as $V_{V+} - V_{OUT}$		0.2	1 **1**	mV mV
		output low, R_L = 100k		0.2	1 **1**	mV mV
		output high, R_L = 2k, specified as $V_{V+} - V_{OUT}$		10	33 **50**	mV mV
		output low, R_L = 2k		10	33 **50**	mV mV
I_{SC}	Output Short Circuit Current **Note 6**	sourcing, V_{OUT} = 0V	30	50		mA
		sinking, V_{OUT} = 2.7V	30	50		mA
A_{VOL}	Voltage Gain	sourcing		400		V/mV
		sinking		400		V/mV
I_s	Supply Current	V_{V+} = 2.7V, V_{OUT} = V_{V+}/2		17	42	μA

AC Electrical Characteristics (2.7V)

V+ = +2.7V, V− = 0V, V_{CM} = V_{OUT} = V_{V+}/2; R_L = 1M; T_J = 25°C, **bold** values indicate −40°C ≤ T_J ≤ +85°C; unless noted

Symbol	Parameter	Condition	Min	Typ	Max	Units
SR	Slew Rate	voltage follower, 1V step, R_L = 100k@1.35V V_{OUT} = $1V_{P-P}$		0.015		V/μs
GBW	Gain Bandwidth Product			25		kHz

DC Electrical Characteristics (5V)

V_{V+} = +5.0V, V_{V-} = 0V, V_{CM} = V_{OUT} = V_{V+}/2; R_L = 1M; T_J = 25°C, **bold** values indicate −40°C ≤ T_J ≤ +85°C; unless noted

Symbol	Parameter	Condition	Min	Typ	Max	Units
V_{OS}	Input Offset Voltage			0.9	7 **9**	mV mV
TCV_{OS}	Input Offset Voltage Temperature Drift			2.0		µV/°C
I_B	Input Bias Current			1	10 **500**	pA pA
I_{OS}	Input Offset Current			0.01	0.5 **75**	pA pA
R_{IN}	Input Resistance			>10		TΩ
+PSRR	Positive Power Supply Rejection Ratio	5V ≤ V_{V+} ≤ 10V, V_{V-} = 0V, V_{CM} = V_{OUT} = 2.5V	65	95		dB
−PSRR	Negative Power Supply Rejection Ratio	−5V ≤ V_{V-} ≤ −10V, V_{V+} = 0V, V_{CM} = V_{OUT} = −2.5V	65	95		dB
CMRR	Common-Mode Rejection Ratio	V_{CM} = −0.2V to +5.2V	57	80		dB
C_{IN}	Common Mode Input Capacitance			3		pF
V_{OUT}	Output Voltage Swing	output high, R_L = 100k, specified as V_{V+} − V_{OUT}		0.3	1.5 **1.5**	mV mV
		output low, R_L = 100k		0.3	1.5 **1.5**	mV mV
		output high, R_L = 2k, specified as V_{V+} − V_{OUT}		15	50 **75**	mV mV
		output low, R_L = 2k		15	50 **75**	mV mV
I_{SC}	Output Short Circuit Current **Note 6**	sourcing, V_{OUT} = 0V	80	100		mA
		sinking, V_{OUT} = 5V	80	100		mA
A_{VOL}	Voltage Gain	sourcing		500		V/mV
		sinking		500		V/mV
I_S	Supply Current	V_{V+} = 5V, V_{OUT} = V_{V+}/2		20	50	µA

AC Electrical Characteristics (5V)

V+ = +5V, V− = 0V, V_{CM} = V_{OUT} = V_{V+}/2; R_L = 1M; T_J = 25°C, **bold** values indicate −40°C ≤ T_J ≤ +85°C; unless noted

Symbol	Parameter	Condition	Min	Typ	Max	Units
SR	Slew Rate	voltage follower, 1V step, R_L = 100k@1.5V V_{OUT} = $1V_{P-P}$		0.02		V/µs
GBW	Gain Bandwidth Product			25		kHz

DC Electrical Characteristics (10V)

V_{V+} = +10V, V_{V-} = 0V, V_{CM} = V_{OUT} = V_{V+}/2; R_L = 1M; T_J = 25°C, **bold** values indicate −40°C ≤ T_J ≤ +85°C; unless noted

Symbol	Parameter	Condition	Min	Typ	Max	Units
V_{OS}	Input Offset Voltage			0.9	7 **9**	mV mV
TCV_{OS}	Input Offset Voltage Temperature Drift			2.0		µV/°C

Symbol	Parameter	Condition	Min	Typ	Max	Units
I_B	Input Bias Current			1	10 **500**	pA pA
I_{OS}	Input Offset Current			0.01	0.5 **75**	pA pA
R_{IN}	Input Resistance			>10		TΩ
+PSRR	Positive Power Supply Rejection Ratio	$5V \leq V_{V+} \leq 10V$, $V_{V-} = 0V$, $V_{CM} = V_{OUT} = 2.5V$	65	95		dB
–PSRR	Negative Power Supply Rejection Ratio	$-5V \leq V_{V-} \leq -10V$, $V_{V+} = 0V$, $V_{CM} = V_{OUT} = -2.5V$	65	95		dB
CMRR	Common-Mode Rejection Ratio	$V_{CM} = -0.2V$ to $+10.2V$	60	85		dB
C_{IN}	Common Mode Input Capacitance			3		pF
V_{OUT}	Output Voltage Swing	output high, $R_L = 100k$, specified as $V_{V+} - V_{OUT}$		0.45	2.5 **2.5**	mV mV
		output low, $R_L = 100k$		0.45	2.5 **2.5**	mV mV
		output high, $R_L = 2k$, specified as $V_{V+} - V_{OUT}$		24	80 **120**	mV mV
		output low, $R_L = 2k$		24	80 **120**	mV mV
I_{SC}	Output Short Circuit Current **Note 6**	sourcing, $V_{OUT} = 0V$	100	200		mA
		sinking, $V_{OUT} = 10V$	100	200		mA
A_{VOL}	Voltage Gain	sourcing		500		V/mV
		sinking		500		V/mV
I_S	Supply Current	$V_{V+} = 10V$, $V_{OUT} = V_{V+}/2$		25	65	µA

AC Electrical Characteristics (10V)

V+ = +10V, V– = 0V, $V_{CM} = V_{OUT} = V_{V+}/2$; $R_L = 1M$; T_J = 25°C, **bold** values indicate $-40°C \leq T_J \leq +85°C$; unless noted

Symbol	Parameter	Condition	Min	Typ	Max	Units
SR	Slew Rate	voltage follower, 1V step, $R_L = 100k$@1.35V $V_{OUT} = 1V_{P-P}$		0.02		V/µs
GBW	Gain Bandwidth Product			25		kHz
ϕ_M	Phase Margin			50		°
G_M	Gain Margin			15		dB
e_N	Input Referred Voltage Noise	f = 1kHz, $V_{CM} = 1.0V$		110		nV/$\sqrt{Hz}$
i_N	Input Referred Current Noise	f = 1kHz		0.03		pA/$\sqrt{Hz}$

General Notes: Devices are ESD protected; however, handling precautions are recommended. All limits guaranteed by testing on statistical analysis.

Note 1: Absolute maximum ratings indicate limits beyond which damage to the component may occur. Electrical specifications do not apply when operating the device outside its recommended operating ratings.

Note 2: I/O Pin Voltage is any external voltage to which an input or output is referenced.

Note 3: The maximum allowable power dissipation is a function of the maximum junction temperature, $T_{J(max)}$; the junction-to-ambient thermal resistance, θ_{JA}; and the ambient temperature, T_A. The maximum allowable power dissipation at any ambient temperature is calculated using: $P_D = (T_{J(max)} - T_A) \div \theta_{JA}$. Exceeding the maximum allowable power dissipation will result in excessive die temperature.

Note 4: Thermal resistance, θ_{JA}, applies to a part soldered on a printed-circuit board.

Note 5: Human body model, 1.5k in series with 100pF.

Note 6: Short circuit may cause the device to exceed maxium allowable power dissipation. See **Note 3**.

Application Information

Input Common-Mode Voltage

The MIC7111 tolerates input overdrive by at least 300mV beyond either rail without producing phase inversion.

If the absolute maximum input voltage is exceeded, the input current should be limited to ± 5mA maximum to prevent reducing reliability. A 10kΩ series input resistor, used as a current limiter, will protect the input structure from voltages as large as 50V above the supply or below ground. See Figure 1.
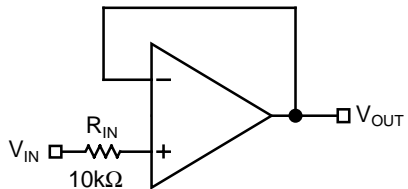

Figure 1. Input Current-Limit Protection

Output Voltage Swing

Sink and source output resistances of the MIC7111 are equal. Maximum output voltage swing is determined by the load and the approximate output resistance. The output resistance is:

$$R_{OUT} = \frac{V_{DROP}}{I_{LOAD}}$$

V_{DROP} is the voltage dropped within the amplifier output stage. V_{DROP} and I_{LOAD} can be determined from the V_O (output swing) portion of the appropriate Electrical Characteristics table. I_{LOAD} is equal to the typical output high voltage minus V+/2 and divided by R_{LOAD}. For example, using the Electrical Characteristics DC (5V) table, the typical output voltage drop using a 2kΩ load (connected to V+/2) is 0.015V, which produces an I_{LOAD} of:

$$\frac{2.5V - 0.015V}{2k\Omega} = 1.243mA$$

then:

$$R_{OUT} = \frac{15mV}{1.243mA} = 12.1 \approx 12\Omega$$

Driving Capacitive Loads

Driving a capacitive load introduces phase-lag into the output signal, and this in turn reduces op-amp system phase margin. The application that is least forgiving of reduced phase margin is a unity gain amplifier. The MIC7111 can typically drive a 500pF capacitive load connected directly to the output when configured as a unity-gain amplifier.

Using Large-Value Feedback Resistors

A large-value feedback resistor (> 500kΩ) can reduce the phase margin of a system. This occurs when the feedback resistor acts in conjunction with input capacitance to create phase lag in the fedback signal. Input capacitance is usually a combination of input circuit components and other parasitic capacitance, such as amplifier input capacitance and stray printed circuit board capacitance.

Figure 2 illustrates a method of compensating phase lag caused by using a large-value feedback resistor. Feedback capacitor C_{FB} introduces sufficient phase lead to overcome the phase lag caused by feedback resistor R_{FB} and input capacitance C_{IN}. The value of C_{FB} is determined by first estimating C_{IN} and then applying the following formula:
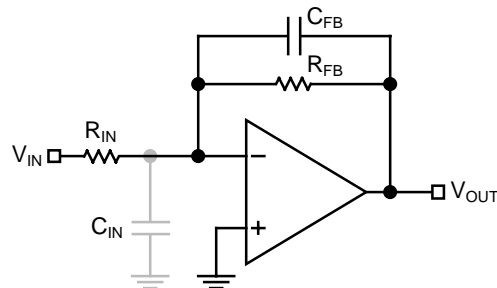
$$R_{IN} \times C_{IN} \leq R_{FB} \times C_{FB}$$

Figure 2. Cancelling Feedback Phase Lag

Since a significant percentage of C_{IN} may be caused by board layout, it is important to note that the correct value of C_{FB} may

change when changing from a breadboard to the final circuit layout.

Typical Circuits

Some single-supply, rail-to-rail applications for which the MIC7111 is well suited are shown in the circuit diagrams of Figures 3 through 7.
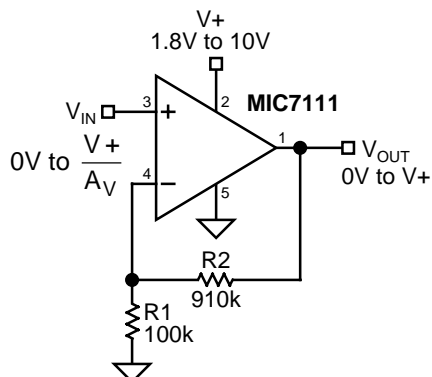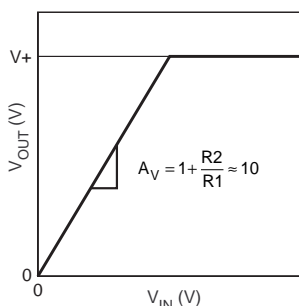
Figure 3a. Noninverting Amplifier

$$A_V = 1 + \frac{R2}{R1} \approx 10$$

Figure 3b. Noninverting Amplifier Behavior

$$V_{OUT} = V_{IN}$$
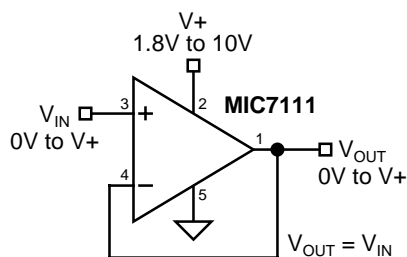
Figure 4. Voltage Follower/Buffer

$$I_{OUT} = \frac{V_{IN}}{R_S} = 100mA/V \text{ as shown}$$
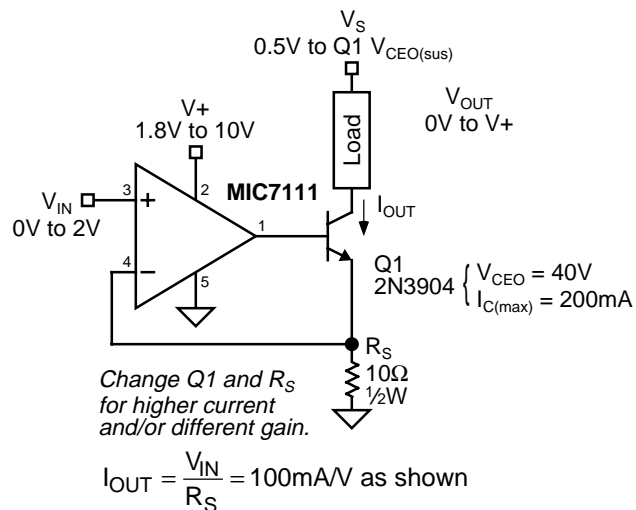
Figure 5. Voltage-Controlled Current Sink
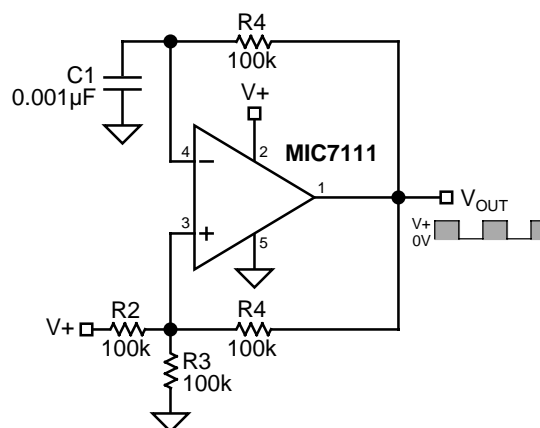
Figure 6. Square Wave Oscillator

$$A_V = -\frac{R2}{R1} = \frac{330k}{33k} = -10$$
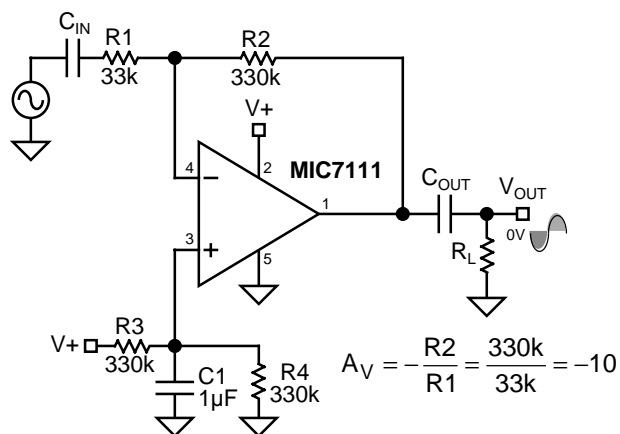
Figure 7. AC-Coupled Inverting Amplifier

Package Information

1.90 (0.075) REF

0.95 (0.037) REF

1.75 (0.069)
1.50 (0.059)

3.00 (0.118)
2.60 (0.102)

DIMENSIONS:
MM (INCH)

3.02 (0.119)
2.80 (0.110)

1.30 (0.051)
0.90 (0.035)

0.20 (0.008)
0.09 (0.004)

10°
0°

0.50 (0.020)
0.35 (0.014)

0.15 (0.006)
0.00 (0.000)

0.60 (0.024)
0.10 (0.004)

SOT-23-5 (M5)